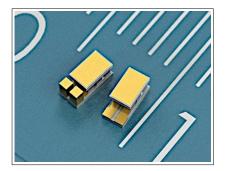


# Performance Parameters

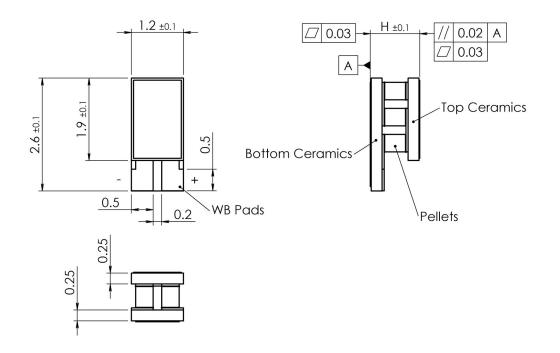
1MD04-003-XX

Туре	ΔT <sub>max</sub> K	Q <sub>max</sub> W	I <sub>max</sub> A	U <sub>max</sub> V	AC R Ohm	H mm
1MD04-003-xx (N=3)						
1MD04-003-03	68	0.50	2.3	0.4	0.12	0.9
1MD04-003-05	70	0.32	1.5		0.19	1.1
1MD04-003-08	72	0.21	0.9		0.30	1.4
1MD04-003-10	72	0.17	0.8		0.37	1.6
1MD04-003-12	72	0.14	0.6		0.45	1.8
1MD04-003-15	73	0.12	0.5		0.56	2.1



Performance data are given for 300K, vacuum

### Dimensions



# Manufacturing options

#### A. TEC Assembly:

- \* 1. Solder SnSb (T<sub>melt</sub>=230°C)
  2. Solder AuSn (T<sub>melt</sub>=280°C)

### B. Ceramics:

- \* 1.Pure Al<sub>2</sub>O<sub>3</sub>(100%)
  2.Alumina (Al<sub>2</sub>O<sub>3</sub>- 96%)
  3.Aluminum Nitride (AlN)
- \* used by default

#### C. Ceramics Surface Options:

- 1. Blank ceramics (not metallized)
- 2. Metallized (Au plating)
- 3. Metallized and pre-tinned with:
  - 3.1 Solder 117 (In-Sn, T<sub>melt</sub> =117°C)
  - 3.2 Solder 138 (Sn-Bi, T<sub>melt</sub> = 138°C)
  - 3.3 Solder 143 (In-Ag, T<sub>melt</sub> = 143°C)
  - 3.4 Solder 157 (In, T<sub>melt</sub> = 157°C)
  - 3.5 Solder 183 (Pb-Sn, T<sub>melt</sub> =183°C)
- 3.6 Optional (specified by Customer)

#### D. Thermistor (optional)

Can be mounted to cold side ceramics edge. Calibration is available by request.

#### E. Terminal contacts

- 1. Blank, tinned Copper
- 2. Insulated Wires
- 3. Insulated, color coded

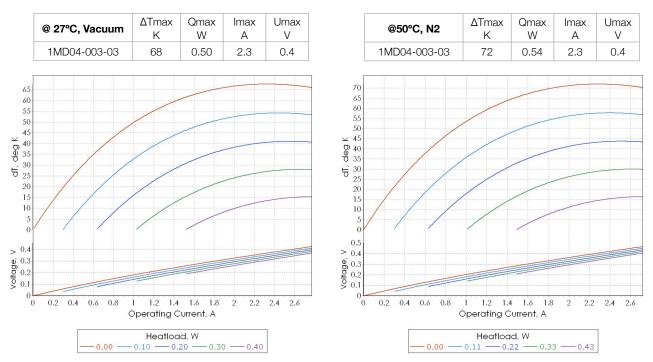
46 Warshavskoe shosse. Moscow 115230 Russia, ph: +7-499-678-2082, fax: +7-499-678-2083, web: www.rmtltd.ru



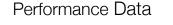
Performance Data

RM1

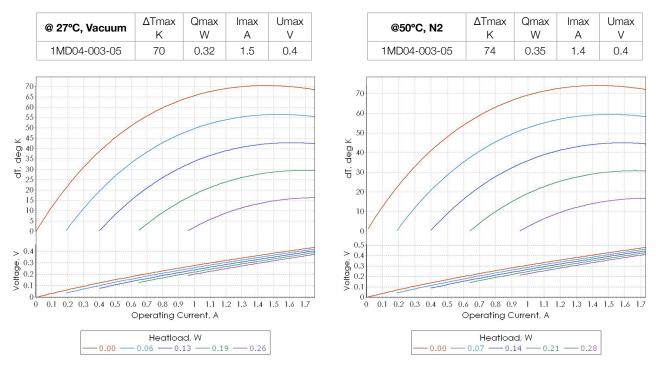
1MD04-003-03



**Note**: Performance data is specified for optimal optimal conditions (TEC hot side is stabilized at ambient temperature). Heatsink thermal resistance is not included into estimations. Use TECCad Software for estimations under different conditions.



# - 1MD04-003-<u>05</u>



**Note**: Performance data is specified at optimal optimal conditions (TEC hot side is stabilized at ambient temperature). Any heatsink thermal resistance is not included into estimations. Use TECCad Software for estimations under different conditions.

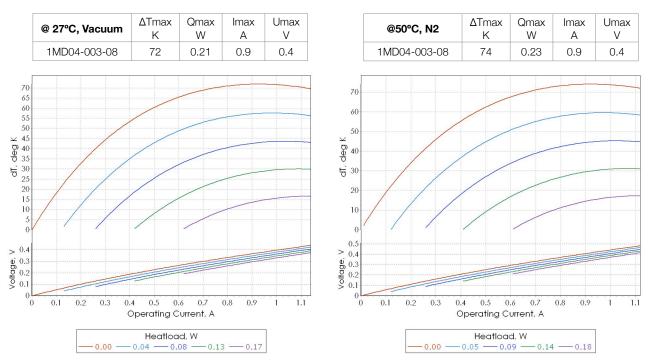
46 Warshavskoe shosse. Moscow 115230 Russia, ph: +7-499-678-2082, fax: +7-499-678-2083, web: www.rmtltd.ru



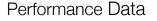
Performance Data

RM1

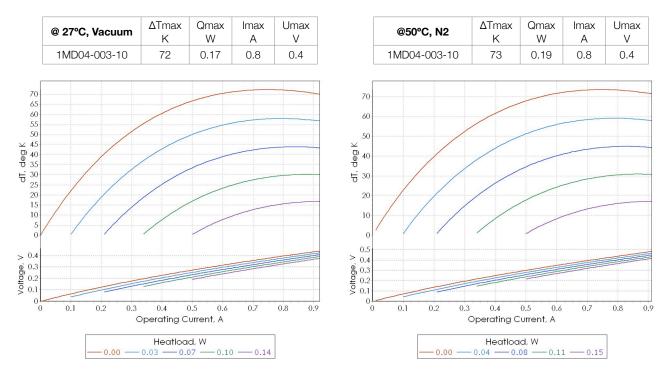
1MD04-003-08



**Note**: Performance data is specified for optimal optimal conditions (TEC hot side is stabilized at ambient temperature). Heatsink thermal resistance is not included into estimations. Use TECCad Software for estimations under different conditions.



# - 1MD04-003-<u>10</u>



**Note**: Performance data is specified for optimal optimal conditions (TEC hot side is stabilized at ambient temperature). Heatsink thermal resistance is not included into estimations. Use TECCad Software for estimations under different conditions.

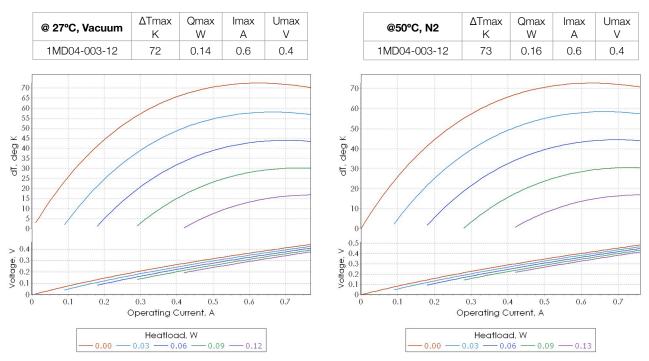
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Performance Data

RM1

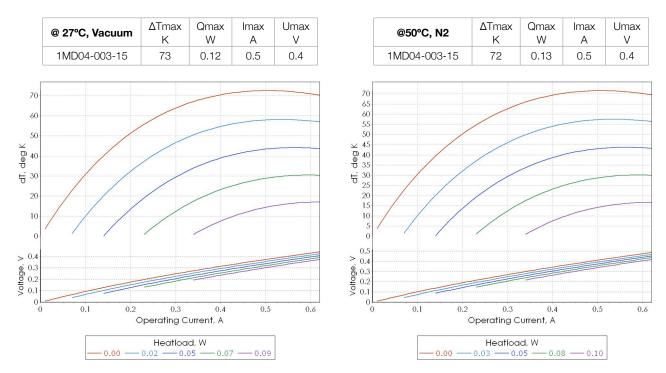
1MD04-003-<u>12</u>



**Note**: Performance data is specified for optimal optimal conditions (TEC hot side is stabilized at ambient temperature). Heatsink thermal resistance is not included into estimations. Use TECCad Software for estimations under different conditions.

Performance Data

# - 1MD04-003-<u>15</u>



**Note**: Performance data is specified for optimal optimal conditions (TEC hot side is stabilized at ambient temperature). Heatsink thermal resistance is not included into estimations. Use TECCad Software for estimations under different conditions.

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Additional Options

### **TEC Polarity**

TEC Polarity can be modified by request. The specified polarity in this datasheet is typical. It can be reversed in accordance to Customer application requirements.

### **Terminal Wires Options**

The standard solution is based on WB pads. Terminal Wires can be attached by request. Various options for terminal wires are available. (blank, isolated wires, isolated color-coded wires, flexible multicore wires and etc).

#### **Optimization for WB process**

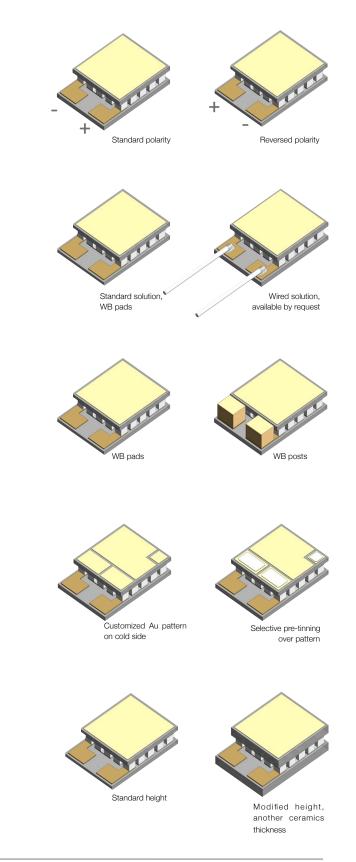
The solution with WB pads (no posts) is provided by default. WB posts are available by request. The dimensions of WB posts can be modified and optimized for Customers application. WB posts are made of Copper, Au plated.

#### **Customized Au Patterns**

Customized Au patterns on thermoelectric cooler cold side are available by request. Selective Pretinning over pattern is also available. Please, contact RMT Ltd for additional information about customized Au patterns requirements.

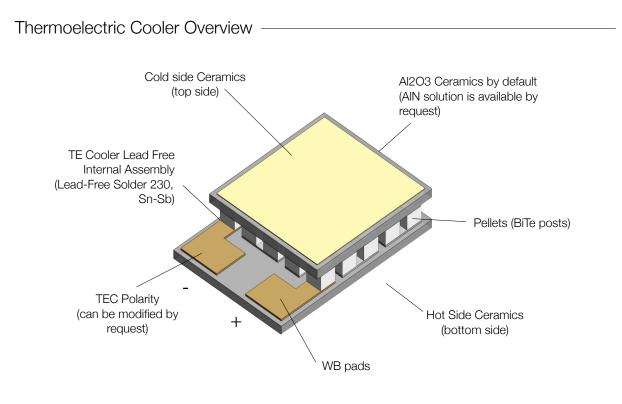
## **TEC Height modification**

Standard TEC height can be modified without performance changes by using ceramics of different thickness. Standard thermoelectric cooler height (specified in this datasheet) can be increased in a range 0.25..1.5 mm by request.



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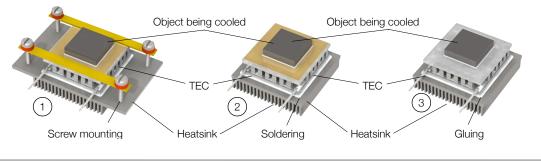


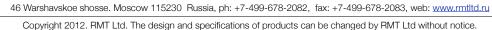
# Application Tips

- 1. Never heat TE module more than 200°C (TEC assembled at 230°C).
- 1. Connect TE module to DC power supply according to polarity.
- 2. Never use TE module without an attached heat sink at hot (bottom) side.
- 2. Do not apply DC current higher than Imax.

# Installation

- 1. <u>Mechanical Mounting</u>. TEC is placed between two heat exchangers. This construction is fixed by screws or in another mechanical way. It is suitable for large modules (with dimensions 30x30mm and larger). Miniature types require other assembling methods in most cases.
- 1. <u>Soldering</u>. This method is suitable for a TE module with metallized outside surfaces. RMT provides this option and also makes pre-tinning for TE modules.
- 2. <u>Glueing</u>. It is an up-to-date method that is used by many customers due to availability of glues with good thermoconductive properties. A glue is usually based on some epoxy compound filled with some thermoconductive material such as graphite or diamond powders, silver, SiN and others. The application of a specific type depends on application features and the type of a TE module.







# Contacts

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